TSM4835

30V P-Channel Enhancement Mode MOSFET

Pin assignment:
1. Source 8. Drain
2. Source 7. Drain
3. Source 6. Drain
4. Gate 5. Drain

V_{DS} = - 30V
$R_{DS\ (on)}$, Vgs @ - 10V, Ids @ - 9.5A =18mΩ
$R_{DS\ (on)}$, Vgs @ - 4.5V, Ids @ - 7.5A =30mΩ

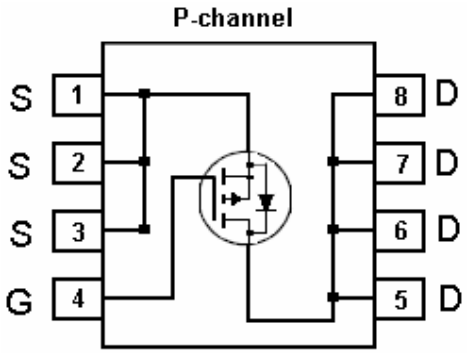
Features

- ✧ Advanced trench process technology
- ✧ High density cell design for ultra low on-resistance
- ✧ High gate voltage

Ordering Information

Part No.	Packing	Package
TSM4835CS	Tape & Reel	SOP-8

Block Diagram



Absolute Maximum Rating (Ta = 25 °C unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 30	V
Gate-Source Voltage		V_{GS}	± 25	V
Continuous Drain Current, V_{GS} @4.5V.		I_D	- 9.5	A
Pulsed Drain Current, V_{GS} @4.5V		I_{DM}	- 50	A
Maximum Power Dissipation	Ta = 25 °C	P_D	2.5	W
	Ta > 25 °C		1.6	W
Operating Junction Temperature		T_J	+150	°C
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit
Junction to Ambient Thermal Resistance (PCB mounted)	Rθja	50	°C/W

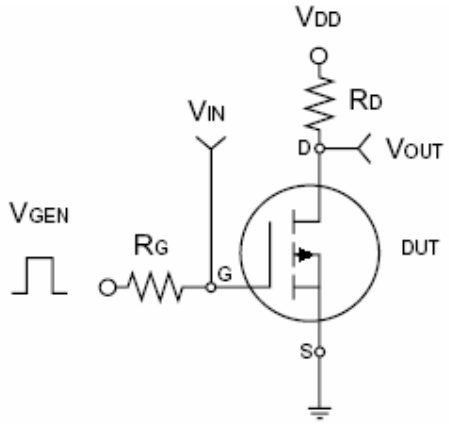
Note: Surface mounted on FR4 board t<=5sec.

Electrical Characteristics

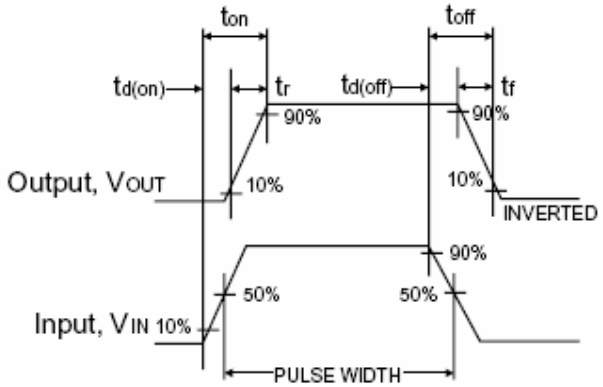
Ta = 25°C, unless otherwise noted

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = - 250uA	BV_{DSS}	- 30	--	--	V
Drain-Source On-State Resistance	V_{GS} = - 10V, I_D = -9.5A	$R_{DS(ON)}$	--	13	18	mΩ
Drain-Source On-State Resistance	V_{GS} = - 4.5V, I_D = -7.5A	$R_{DS(ON)}$	--	22	30	
Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = - 250uA	$V_{GS(TH)}$	- 1	--	- 3	V
Zero Gate Voltage Drain Current	V_{DS} = - 30V, V_{GS} = 0V	I_{DSS}	--	--	- 1.0	uA
Gate Body Leakage	V_{GS} = ± 25V, V_{DS} = 0V	I_{GSS}	--	--	± 100	nA
Forward Transconductance	V_{DS} = - 15V, I_D = - 8A	g_{fs}	--	22	--	S
Dynamic						
Total Gate Charge	V_{DS} = - 15V, I_D = - 4.6A, V_{GS} = - 5V	Q_g	--	23	34	nC
	V_{DS} = - 15V, I_D = - 4.6A, V_{GS} = - 10V		--	54	60	
Gate-Source Charge		Q_{gs}	--	8.5	--	
Gate-Drain Charge		Q_{gd}	--	10.3	--	
Turn-On Delay Time	V_{DD} = - 15V, R_L = 15Ω, I_D = - 1A, V_{GEN} = - 10V, R_G = 6Ω	$t_{d(on)}$	--	24	30	nS
Turn-On Rise Time		t_r	--	12	30	
Turn-Off Delay Time		$t_{d(off)}$	--	78	120	
Turn-Off Fall Time		t_f	--	37	80	
Input Capacitance	V_{DS} = - 15V, V_{GS} = 0V, f = 1.0MHz	C_{iss}	--	2520	--	pF
Output Capacitance		C_{oss}	--	490	--	
Reverse Transfer Capacitance		C_{rss}	--	330	--	
Source-Drain Diode						
Max. Diode Forward Current		I_S	--	--	- 2.1	A
Diode Forward Voltage	I_S = - 2.1A, V_{GS} = 0V	V_{SD}	--	- 0.77	- 1.2	V

Note : pulse test: pulse width <=300uS, duty cycle <=2%

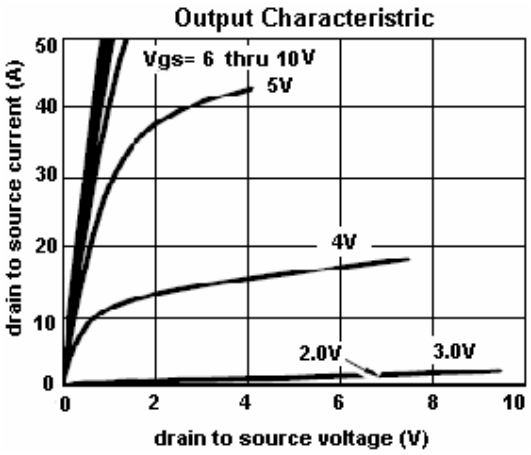


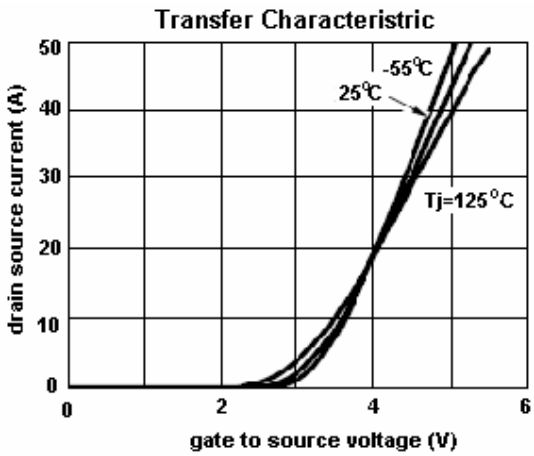
Switching Test Circuit

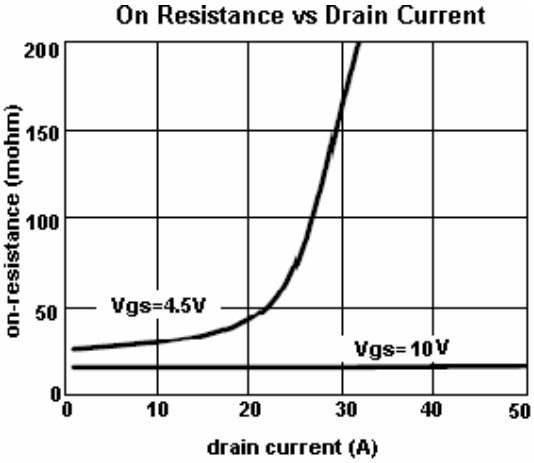


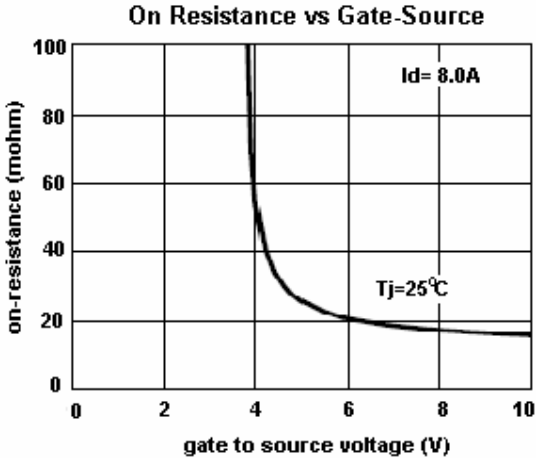
Switchin Waveforms

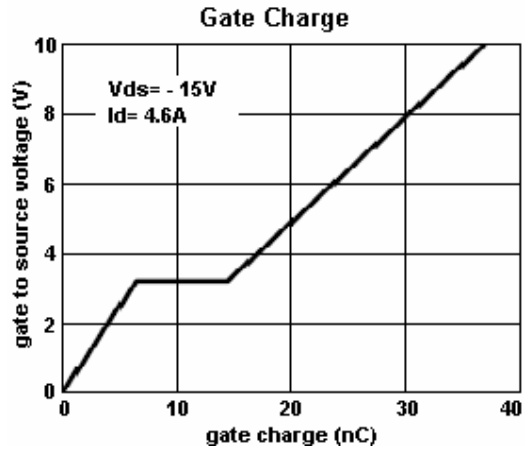
Typical Characteristics Curve (Ta = 25 °C unless otherwise noted)

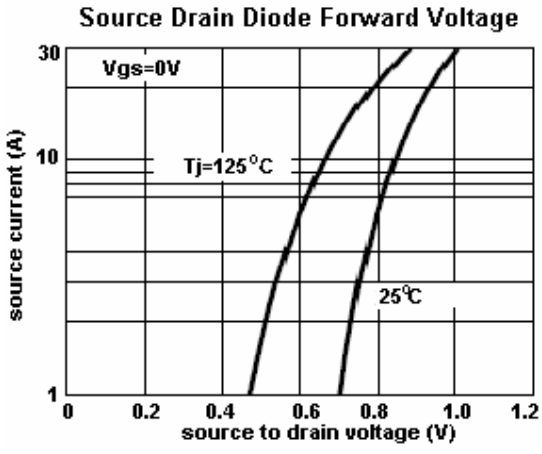




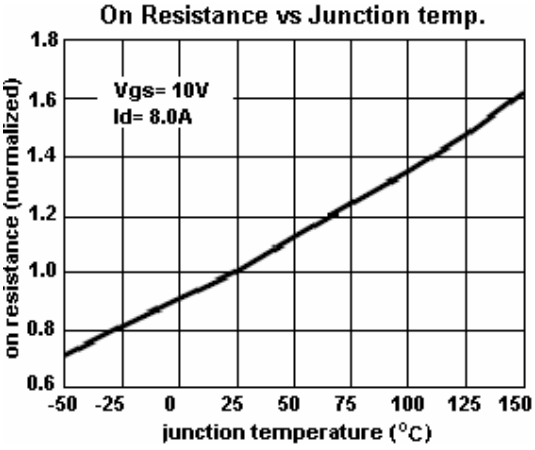


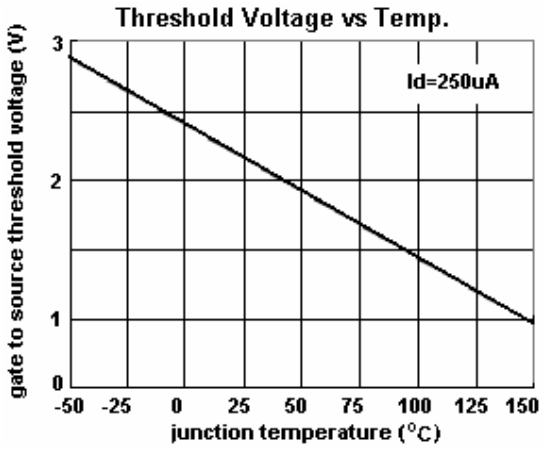


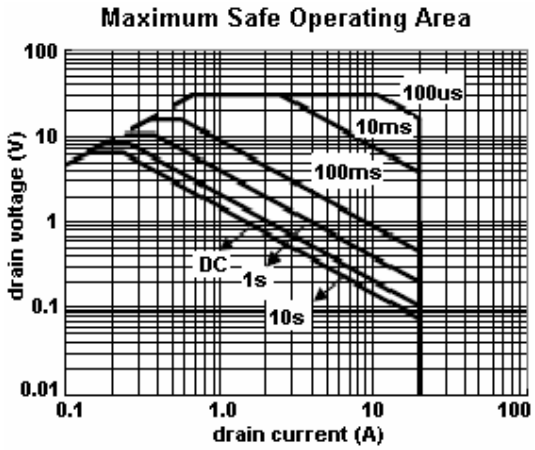


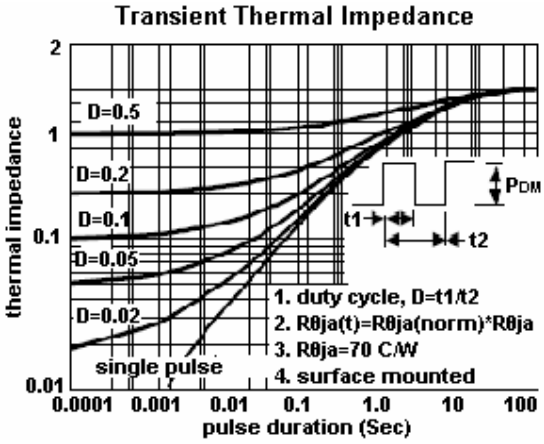


Electrical Characteristics Curve (continued)

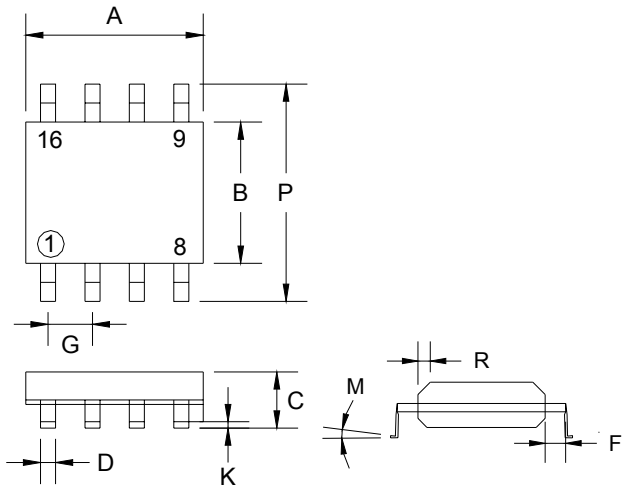








SOP-8 Mechanical Drawing



SOP-8 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.196
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 (typ)		0.05 (typ)	
K	0.10	0.25	0.004	0.009
M	0^o	7^o	0^o	7^o
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019